






















Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0.40mil	3.5
4		Top Layer	Copper	1.38mil	
5		Dielectric 1	PP-017	5.10mil	4.3
6		Layer 1	Copper	1.38mil	
7		Dielectric 2	Core-023	7.50mil	4.2
8		Layer 2	Copper	1.38mil	
9		Dielectric 3	PP-017	5.10mil	4.3
10		Layer 3	Copper	1.38mil	
11		Dielectric 4	Core-025	8.00mil	4.6
12		Layer 4	Copper	1.38mil	
13		Dielectric 5	PP-017	5.10mil	4.3
14		Layer 5	Copper	1.38mil	
15		Dielectric 6	Core-023	7.50mil	4.2
16		Layer 6	Copper	1.38mil	
17		Dielectric 7	PP-017	5.10mil	4.3
18		Bottom Layer	Copper	1.38mil	
19		Bottom Solder	Solder Resist	0.40mil	3.5
20		Bottom Overlay			
21		Bottom Paste			
Height : 55.22mil					